# Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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# DMPOUND FIELD EFFECT POWER TRANSISTOR $\mu$ PA 1600

# **MONOLITHIC POWER MOS FET ARRAY**

### **DESCRIPTION**

The  $\mu$ PA1600 is Monolithic N-channel Power MOS FET Array that built in 8 circuits and Gate Protection Diode designed for LED, Relay, Thermal Head, and so on.

### **FEATURES**

- Direct driving is possible by standard Logic IC or Microcomputer.
   (4 V driving is possible)
- Output Voltage: Vo = 30 V MAX.
   Output Current: Io = 500 mA MAX.
- Ron = 3  $\Omega$  at: lo = 200 mA, Vi = 4 V
- Gate Protection Diode, built in.

# ORDERING INFORMATION

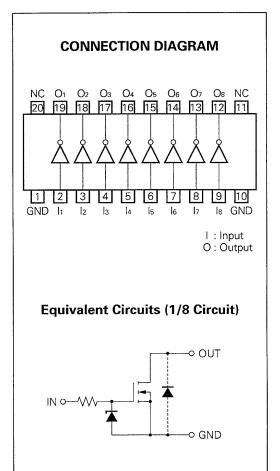
Part Number	Package	Quality Grade
μPA1600CX	20-Pin DIP	Standard
μPA1600GS	20-Pin SOP	Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

# ABSOLUTE MAXIMUM RATINGS ( $T_a = 25 \, ^{\circ}C$ )

Output Voltage	Vo	30	V
Input Voltage	Vı	-0.5 to +10	V
Output Current	lo	500	mA/unit
Input Current	li	±10	mA/unit
GND Terminal Current*	IGND	2.0	Α
Total Power Dissipation	Рт	1.0	W/PKG
Operating Temperature	$T_{opt}$	-40 to +85	°C
Storage Temperature	$T_{\text{stg}}$	-55 to +150	°C

<sup>\*</sup> Case of 2 GND terminals set up 0 V level





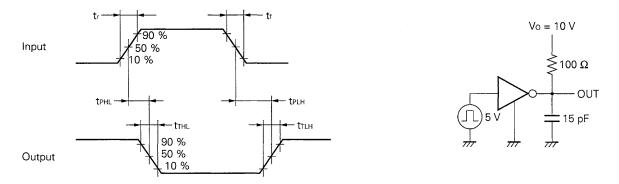
# RECOMMENDED OPERATING CONDITIONS ( $T_a = -40 \text{ to } +85 \text{ }^{\circ}\text{C}$ )

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Output Voltage	Vo			25	V	
Output Current	lo			300	mA/unit	DC, 1 circuit
	IO(pulse)			150	mA/unit	PW ≦ 10 ms, Duty Cycle ≦ 50 %, 8 circuits
High-Level Input Voltage	ViH	4			V	
Low-Level Input Voltage	VIL			0.8	V	

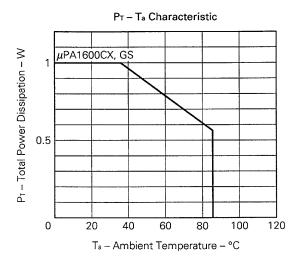
# ELECTRICAL CHARACTERISTICS ( $T_a = 25$ °C)

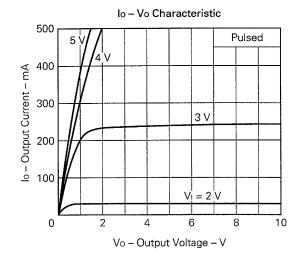
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Output Leakage Current	lo(off)			10	μΑ	VI = 0, Vo = 30 V
Output On-state Resistance	Ron		3	4	Ω	Vı = 4 V, lo = 200 mA
Output On state Valters	V0(0N)1			0.1	V	V <sub>I</sub> = 5 V, I <sub>O</sub> = 10 mA
Output On-state Voltage	Vo(on)2			0.8	V	V <sub>I</sub> = 5 V, I <sub>O</sub> = 200 mA
	Vi(OFF)			0.8	V	Vo = 30 V, Io = 100 μA
Input Voltage	V1(0N)1	2			V	Vo = 0.8 V, Io = 1 mA
	VI(ON)2	4			٧	Vo = 0.8 V, Io = 200 mA
In most Comment	Ін			1	μΑ	V <sub>I</sub> = 8 V, V <sub>O</sub> = 0 V
Input Current	lıc			-1	μΑ	Vı = 0 V, Vo = 20 V
Input Capacitance	Ciss		28		pF	V <sub>I</sub> = 0 V
Output Capacitance	Coss		23		pF	Vo = 10 V
Reverse Transfer Capacitance	Crss		13		pF	f = 1 MHz
Dolou Time	<b>T</b> PHL		50		ns	Vo = 10 V, Rι = 100 Ω
Delay Time	<b>t</b> PLH		250		ns	C <sub>L</sub> = 15 pF
Rise Time	<b>t</b> TLH		220		ns	tr, tr≦5 ns
Fall Time	<b>t</b> THL		180		ns	See Fig. 1

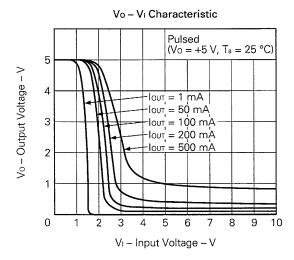
Fig. 1 Switching Wave Forms and Test Circuits

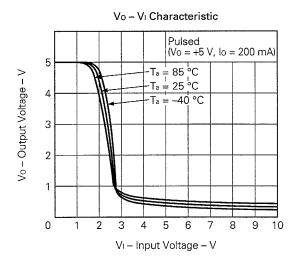


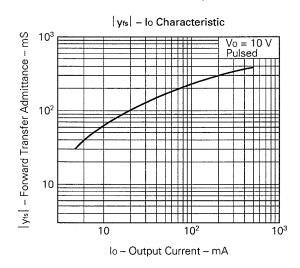
# TYPICAL CHARACTERISTICS (Ta = 25 °C)

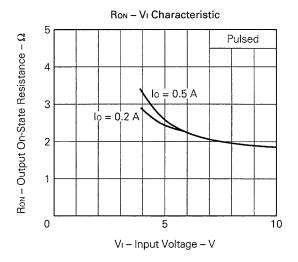


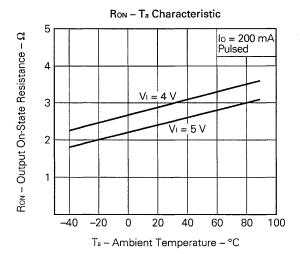


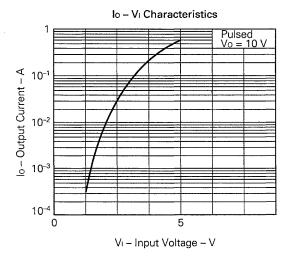


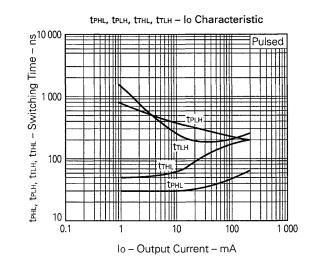


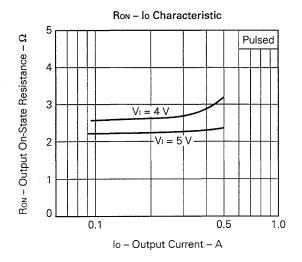


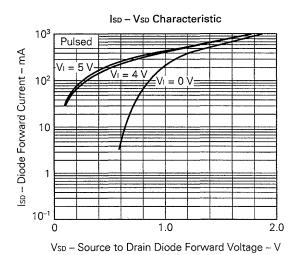


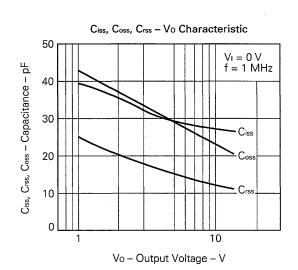








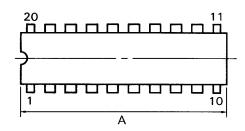


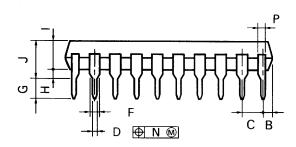


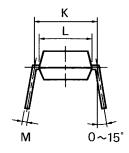
# **PACKAGE DIMENSIONS**

# • μPA1600CX

# 20PIN PLASTIC DIP (300 mil)







P20C-100-300A,C

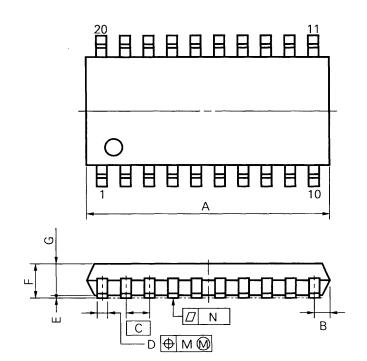
# **NOTES**

- Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS	INCHES
Α	25.40 MAX.	1.000 MAX.
В	1.27 MAX.	0.050 MAX.
С	2.54 (T.P.)	0.100 (T.P.)
D	0.50 <sup>± 0.10</sup>	0.020 -0.004
F	1.1 MIN.	0.043 MIN.
G	3.5 <sup>±0.3</sup>	0.138 <sup>±0.012</sup>
Н	0.51 MIN.	0.020 MIN.
ı	4.31 MAX.	0.170 MAX.
J	5.08 MAX.	0.200 MAX.
К	7.62 (T.P.)	0.300 (T.P.)
L	6.4	0.252
М	0.25 +0.10	0.010 +0.004
N	0.25	0.01
Р	0.9 MIN.	0.035 MIN.

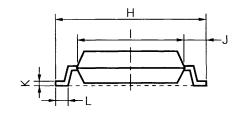
# • μPA1600GS

# 20 PIN PLASTIC SOP (300 mil)





detail of lead end



# NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

# P20GM-50-300B,C-3

ITEM	MILLIMETERS	INCHES
Α	13.00 MAX.	0.512 MAX.
В	0.78 MAX	0.031 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	$0.40^{+0.10}_{-0.05}$	0.016+0.004
E	0.1±0.1	0.004±0.004
F	1.8 MAX.	0.071 MAX.
G	1.55	0.061
Н	7.7±0.3	0.303±0.012
1	5.6	0.220
J	1.1	0.043
K	0.20+0.10	0.008+0.004
L	0.6±0.2	0.024+0.008
М	0.12	0.005
N	0.10	0.004



# RECOMMENDED SOLDERING CONDITIONS

The following conditions (see table below) must be set when soldering this product.

Please consult with our sales offices in case other soldering process is used, or in case soldering is done under different conditions.

# **TYPES OF SURFACE MOUNT DEVICE**

For more details, refer to our document "SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL" (IEI-1207).

# $\mu$ PA1600GS

Soldering process	Soldering conditions	Symbol
Infrared ray reflow	Peak package's surface temperature: 235 °C or below, Reflow time: 30 seconds or below (210 °C or higher), Number of reflow process: Inside of 2 times, Exposure limit*: None	IR35-00-2
VPS	Peak package's surface temperature: 215 °C or below, Reflow time: 40 seconds or below (200 °C or higher), Number of reflow process: Inside of 2 times, Exposure limit*: None	VP15-00-2
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below, Number of flow process: 1, Exposure Limit*: None	WS-60-00-1

<sup>\*:</sup> Exposure limit before soldering after dry-pack package is opened. Storage conditions: 25 °C and relative humidity at 65 % or less.

Note: Do not apply more than a single process at once, except for "Partial heating method".

# TYPES OF THROUGH HOLE MOUNT DEVICE

# $\mu$ PA1600CX

Soldering process	Soldering conditions	Symbol
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or below	

# Reference

Document name	Document No.
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207
Semiconductor device package manual	IEI-1213
SMD surface mount technology manual	IEI-1207

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